

74LVC132A

Quad 2-input NAND Schmitt trigger

Rev. 3 — 7 December 2011

Product data sheet

1. General description

The 74LVC132A provides four 2-input NAND gates with Schmitt trigger inputs. It is capable of transforming slowly-changing input signals into sharply defined, jitter-free output signals.

The inputs switch at different points for positive and negative-going signals. The difference between the positive voltage V_{T+} and the negative voltage V_{T-} is defined as the input hysteresis voltage V_H .

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V environment.

2. Features and benefits

- Wide supply voltage range from 1.2 V to 3.6 V
- 5 V tolerant inputs for interfacing with 5 V logic
- CMOS low-power consumption
- Direct interface with TTL levels
- Unlimited input rise and fall times
- Inputs accept voltages up to 5.5 V
- Complies with JEDEC standard JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - ◆ MM JESD22-A115-B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40°C to $+85^{\circ}\text{C}$ and -40°C to $+125^{\circ}\text{C}$

3. Applications

- Wave and pulse shapers for highly noisy environments
- Astable multivibrator
- Monostable multivibrator.

nexperia

4. Ordering information

Table 1. Ordering information

Type number	Package	Temperature range	Name	Description	Version
74LVC132AD	SO14	-40 °C to +125 °C		plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74LVC132APW	TSSOP14	-40 °C to +125 °C		plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74LVC132ABQ	DHVQFN14	-40 °C to +125 °C		plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	SOT762-1

5. Functional diagram

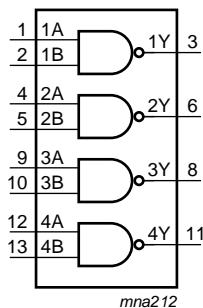


Fig 1. Logic symbol

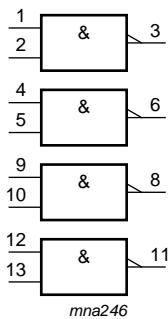


Fig 2. IEC logic symbol

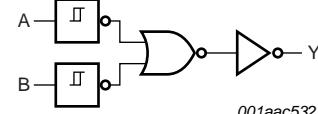


Fig 3. Logic diagram (one gate)

6. Pinning information

6.1 Pinning

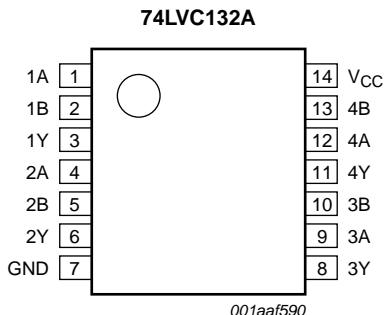
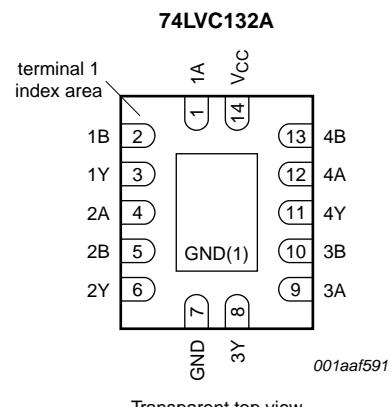


Fig 4. Pin configuration SO14 and TSSOP14



- (1) The die substrate is attached to this pad using conductive die attach material. It can not be used as a supply pin or input.

Fig 5. Pin configuration DHVQFN14

6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1A	1	data input
1B	2	data input
1Y	3	data output
2A	4	data input
2B	5	data input
2Y	6	data output
GND	7	ground (0 V)
3Y	8	data output
3A	9	data input
3B	10	data input
4Y	11	data output
4A	12	data input
4B	13	data input
V _{CC}	14	supply voltage

7. Functional description

Table 3. Function table^[1]

Input		Output
nA	nB	nY
L	L	H
L	H	H
H	L	H
H	H	L

[1] H = HIGH voltage level;
L = LOW voltage level.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
V _I	input voltage	^[1]	-0.5	+6.5	V
V _O	output voltage	^{[2][3]}	-0.5	V _{CC} + 0.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
I _{OK}	output clamping current	V _O > V _{CC} or V _O < 0 V	-	±50	mA
I _O	output current	V _O = 0 V to V _{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	T _{amb} = -40 °C to +125 °C	^[4] -	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] When V_{CC} = 0 V (Power-down mode), the output voltage can be 3.6 V in normal operation.

[4] For SO14 packages: P_{tot} derates linearly with 8 mW/K above 70 °C.

For TSSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

For DHVQFN14 packages: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V _I	input voltage		0	-	5.5	V
V _O	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ ^[1]	Max	Unit
T_{amb} = -40 °C to +85 °C						
V _{OH}	HIGH-level output voltage	V _I = V _{T+} or V _{T-} I _O = -100 µA; V _{CC} = 1.65 V to 3.6 V I _O = -4 mA; V _{CC} = 1.65 V I _O = -8 mA; V _{CC} = 2.3 V I _O = -12 mA; V _{CC} = 2.7 V I _O = -18 mA; V _{CC} = 3.0 V I _O = -24 mA; V _{CC} = 3.0 V	V _{CC} - 0.2	-	-	V
			V _{CC} - 0.45	-	-	V
			V _{CC} - 0.5	-	-	V
			V _{CC} - 0.5	-	-	V
			V _{CC} - 0.6	-	-	V
			V _{CC} - 0.8	-	-	V
V _{OL}	LOW-level output voltage	V _I = V _{T+} or V _{T-} I _O = 100 µA; V _{CC} = 1.65 V to 3.6 V I _O = 4 mA; V _{CC} = 1.65 V I _O = 8 mA; V _{CC} = 2.3 V I _O = 12 mA; V _{CC} = 2.7 V I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.2	V
			-	-	0.45	V
			-	-	0.6	V
			-	-	0.4	V
			-	-	0.55	V
I _I	input leakage current	V _{CC} = 3.6 V; V _I = 5.5 V or GND	-	±0.1	±5	µA
I _{CC}	supply current	V _{CC} = 3.6 V; V _I = V _{CC} or GND; I _O = 0 A	-	0.1	10	µA
ΔI _{CC}	additional supply current	per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A	-	5	500	µA
C _I	input capacitance	V _{CC} = 0 V to 3.6 V; V _I = GND to V _{CC}	-	4.0	-	pF
T_{amb} = -40 °C to +125 °C						
V _{OH}	HIGH-level output voltage	V _I = V _{T+} or V _{T-} I _O = -100 µA; V _{CC} = 1.65 V to 3.6 V I _O = -4 mA; V _{CC} = 1.65 V I _O = -8 mA; V _{CC} = 2.3 V I _O = -12 mA; V _{CC} = 2.7 V I _O = -18 mA; V _{CC} = 3.0 V I _O = -24 mA; V _{CC} = 3.0 V	V _{CC} - 0.3	-	-	V
			V _{CC} - 0.6	-	-	V
			V _{CC} - 0.65	-	-	V
			V _{CC} - 0.65	-	-	V
			V _{CC} - 0.75	-	-	V
			V _{CC} - 1	-	-	V
V _{OL}	LOW-level output voltage	V _I = V _{T+} or V _{T-} I _O = 100 µA; V _{CC} = 1.65 V to 3.6 V I _O = 4 mA; V _{CC} = 1.65 V I _O = 8 mA; V _{CC} = 2.3 V I _O = 12 mA; V _{CC} = 2.7 V I _O = 24 mA; V _{CC} = 3.0 V	-	-	0.3	V
			-	-	0.65	V
			-	-	0.8	V
			-	-	0.6	V
			-	-	0.8	V
I _I	input leakage current	V _{CC} = 3.6 V; V _I = 5.5 V or GND	-	-	±20	µA
I _{CC}	supply current	V _{CC} = 3.6 V; V _I = V _{CC} or GND; I _O = 0 A	-	-	40	µA
ΔI _{CC}	additional supply current	per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V; I _O = 0 A	-	-	5	mA

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

11. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 7](#).

Symbol	Parameter	Conditions	-40 °C to +85 °C			-40 °C to +125 °C		Unit
			Min	Typ ^[1]	Max	Min	Max	
t_{pd}	propagation delay	nA, nB to nY; see Figure 6 [2]						
		$V_{CC} = 1.2 \text{ V}$	-	18.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2.0	7.2	12.8	2.0	16.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.5	4.0	7.6	1.5	9.6	ns
		$V_{CC} = 2.7 \text{ V}$	1.5	3.8	7.6	1.5	9.6	ns
$t_{sk(o)}$	output skew time		[3]	-	-	1.0	-	1.5 ns
		per buffer; $V_I = \text{GND to } V_{CC}$	[4]					
C_{PD}	power dissipation capacitance	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	10.5	-	-	-	pF
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	10.8	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	11.4	-	-	-	pF

[1] Typical values are measured at $T_{amb} = 25 \text{ }^{\circ}\text{C}$ and $V_{CC} = 1.2 \text{ V}, 1.8 \text{ V}, 2.5 \text{ V}, 2.7 \text{ V}$, and 3.3 V respectively.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

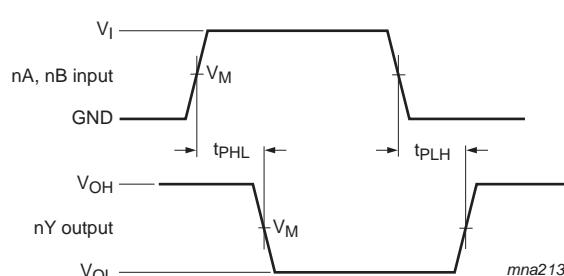
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

$\sum(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

12. Waveforms

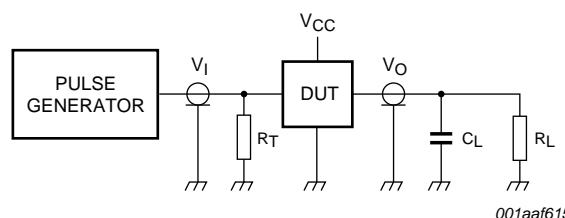
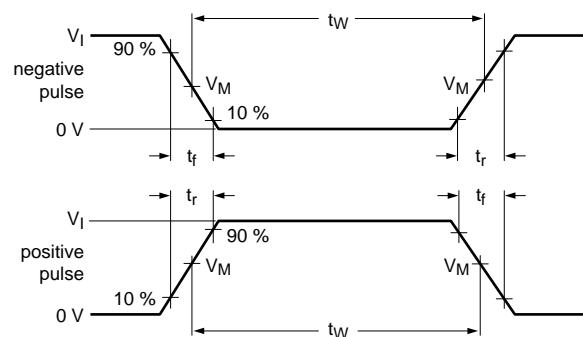


$V_M = 1.5 \text{ V at } V_{CC} \geq 2.7 \text{ V.}$

$V_M = 0.5 \times V_{CC} \text{ at } V_{CC} < 2.7 \text{ V.}$

V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 6. The input (nA, nB) to output (nY) propagation delays



001aa/615

Test data is given in [Table 8](#). Definitions for test circuit:

R_L = Load resistance

C_L = Load capacitance including jig and probe capacitance

R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

Fig 7. Load circuitry for measuring switching times

Table 8. Test data

Supply voltage	Input		Load	
	V _I	t _r , t _f	C _L	R _L
1.2 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ
1.65 V to 1.95 V	V _{CC}	≤ 2 ns	30 pF	1 kΩ
2.3 V to 2.7 V	V _{CC}	≤ 2 ns	30 pF	500 Ω
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω

13. Transfer characteristics

Table 9. Transfer characteristics

Voltages are referenced to GND (ground = 0 V); see [Figure 8](#).

Symbol	Parameter	Conditions	−40 °C to +85 °C		−40 °C to +125 °C		Unit
			Min	Max	Min	Max	
V_{T+}	positive-going threshold voltage	$V_{CC} = 1.2 \text{ V}$	0.2	1.0	0.2	1.0	V
		$V_{CC} = 1.65 \text{ V}$	0.4	1.3	0.4	1.3	V
		$V_{CC} = 1.95 \text{ V}$	0.6	1.5	0.6	1.5	V
		$V_{CC} = 2.3 \text{ V}$	0.8	1.7	0.8	1.7	V
		$V_{CC} = 2.5 \text{ V}$	0.9	1.7	0.9	1.7	V
		$V_{CC} = 2.7 \text{ V}$	1.1	2	1.1	2	V
		$V_{CC} = 3 \text{ V}$	1.2	2	1.2	2	V
		$V_{CC} = 3.6 \text{ V}$	1.2	2	1.2	2	V
V_{T-}	negative-going threshold voltage	$V_{CC} = 1.2 \text{ V}$	0.12	0.75	0.12	0.75	V
		$V_{CC} = 1.65 \text{ V}$	0.15	0.85	0.15	0.85	V
		$V_{CC} = 1.95 \text{ V}$	0.25	0.95	0.25	0.95	V
		$V_{CC} = 2.3 \text{ V}$	0.4	1.1	0.4	1.1	V
		$V_{CC} = 2.5 \text{ V}$	0.4	1.2	0.4	1.2	V
		$V_{CC} = 2.7 \text{ V}$	0.8	1.4	0.8	1.4	V
		$V_{CC} = 3 \text{ V}$	0.8	1.5	0.8	1.5	V
		$V_{CC} = 3.6 \text{ V}$	0.8	1.5	0.8	1.5	V
V_H	hysteresis voltage ($V_{T+} - V_{T-}$)	$V_{CC} = 1.2 \text{ V}$	0.1	1.0	0.1	1.0	V
		$V_{CC} = 1.65 \text{ V}$	0.2	1.15	0.2	1.15	V
		$V_{CC} = 1.95 \text{ V}$	0.2	1.25	0.2	1.25	V
		$V_{CC} = 2.3 \text{ V}$	0.3	1.3	0.3	1.3	V
		$V_{CC} = 2.5 \text{ V}$	0.3	1.3	0.3	1.3	V
		$V_{CC} = 2.7 \text{ V}$	0.3	1.1	0.3	1.1	V
		$V_{CC} = 3 \text{ V}$	0.3	1.2	0.3	1.2	V
		$V_{CC} = 3.6 \text{ V}$	[1]	0.3	1.2	0.3	V

[1] Typical transfer characteristic is displayed in [Figure 9](#).

14. Waveforms transfer characteristics

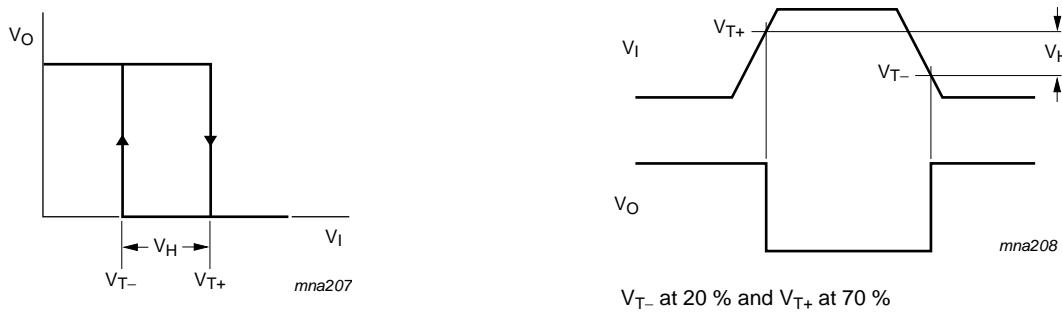
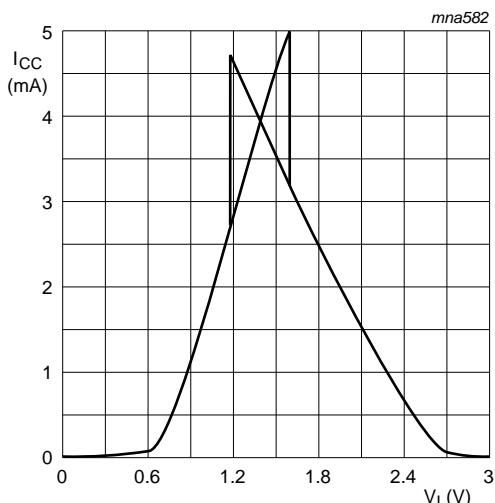


Fig 8. Definition of V_{T+} , V_{T-} and V_H



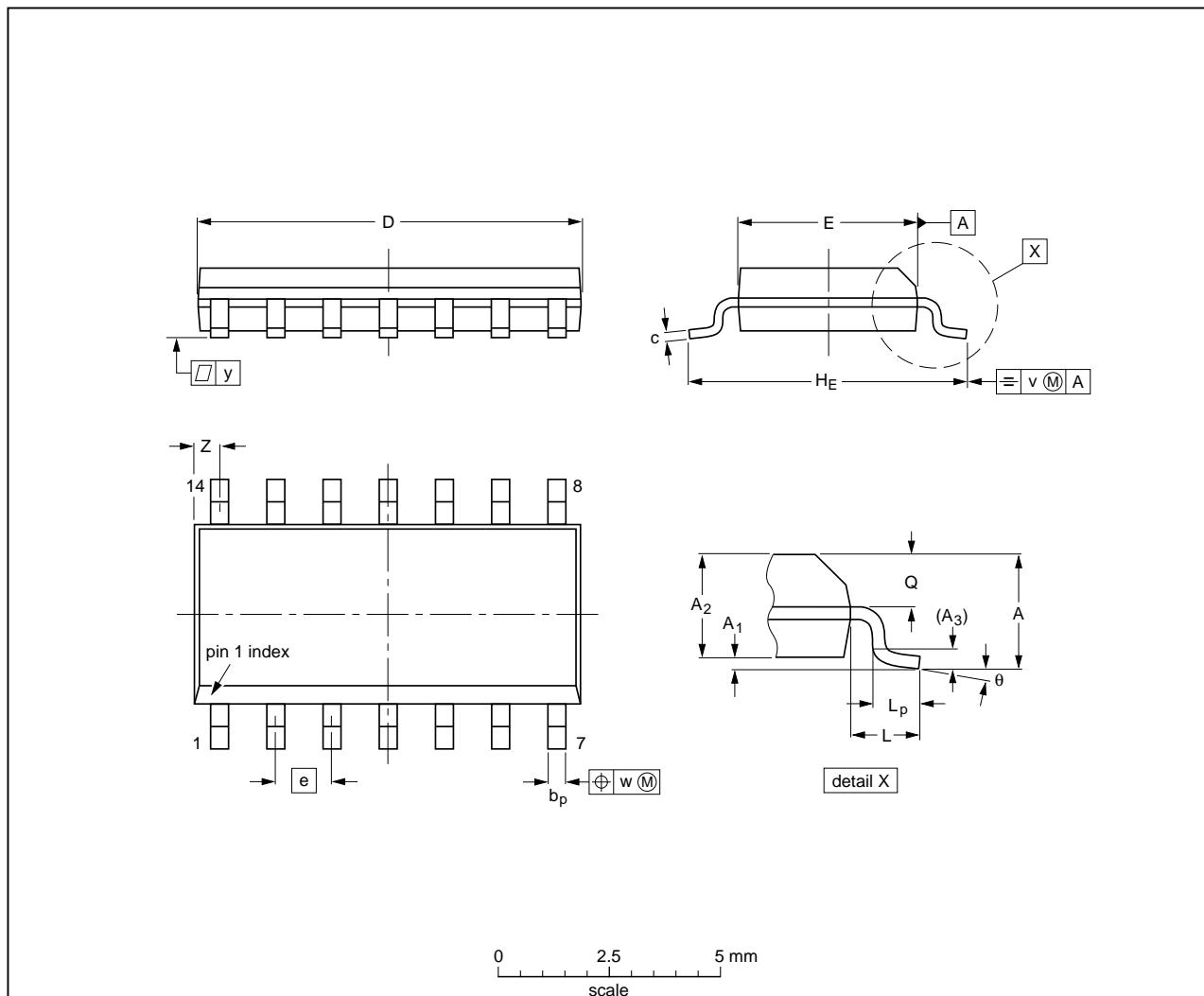
$V_{CC} = 3.3$ V.

Fig 9. Typical transfer characteristic

15. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	1.75 0.10	0.25 0.19	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069 0.004	0.010 0.049	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.35 0.34	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	0°

Note

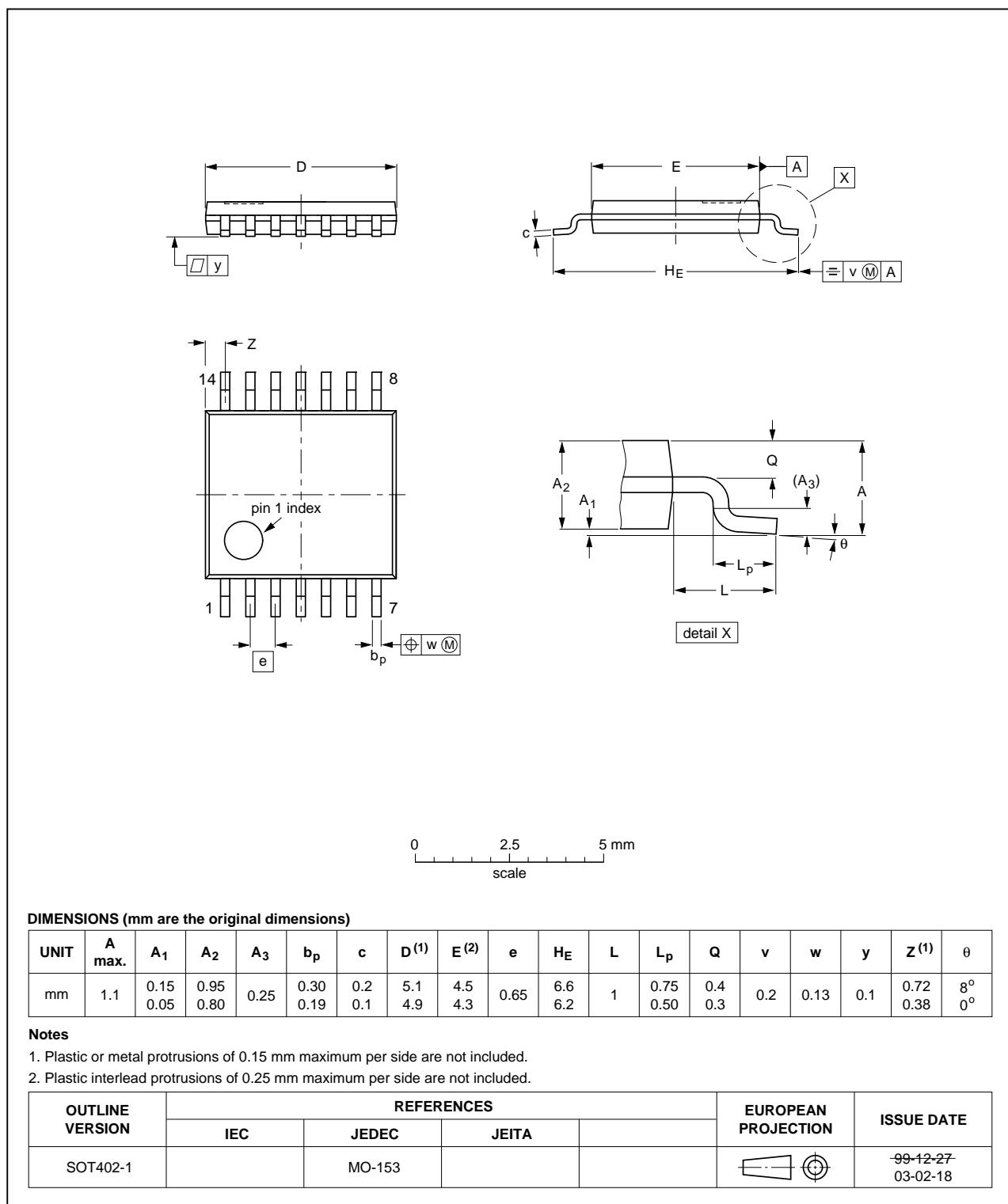
1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT108-1	076E06	MS-012				99-12-27 03-02-19

Fig 10. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

**DIMENSIONS (mm are the original dimensions)**

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	1.1 0.05	0.15 0.80	0.95 0.25	0.25 0.19	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
SOT402-1		MO-153			-99-12-27 03-02-18

Fig 11. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads;
14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

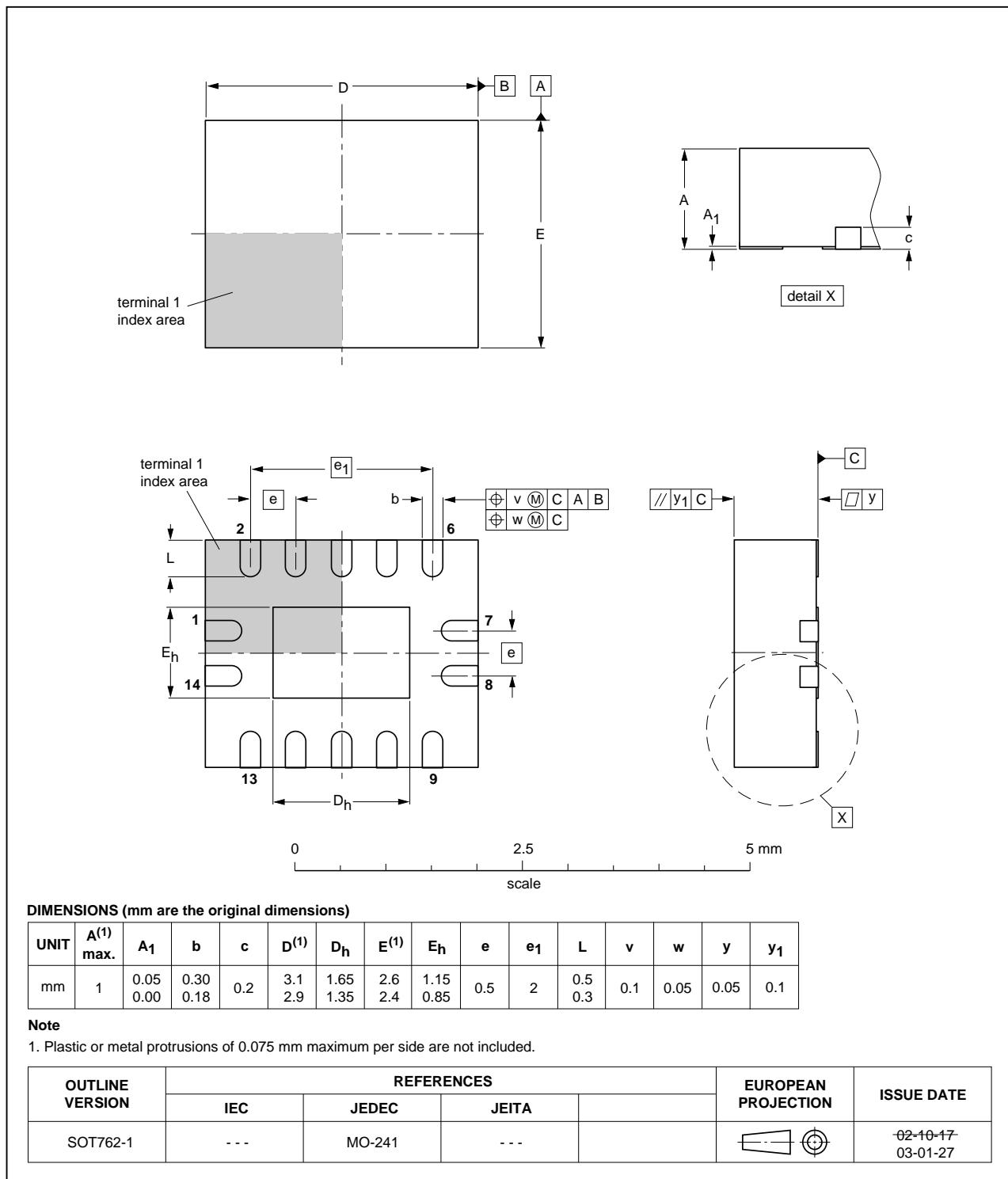


Fig 12. Package outline SOT762-1 (DHVQFN14)

16. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

17. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC132A v.3	20111207	Product data sheet	-	74LVC132A v.2
Modifications:		• Legal pages updated.		
74LVC132A v.2	20110829	Product data sheet	-	74LVC132A v.1
74LVC132A v.1	20061215	Product data sheet	-	-

18. Legal information

18.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

18.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

malfuction of a Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia accepts no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nexperia.com/profile/terms>, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

18.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

Non-automotive qualified products — Unless this data sheet expressly states that this specific Nexperia product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Nexperia accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Nexperia's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

Nexperia's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Nexperia for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Nexperia's standard warranty and Nexperia's product specifications.

18.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

19. Contact information

For more information, please visit: <http://www.nexperia.com>

For sales office addresses, please send an email to: salesaddresses@nexperia.com

20. Contents

1	General description	1
2	Features and benefits	1
3	Applications	1
4	Ordering information	2
5	Functional diagram	2
6	Pinning information	3
6.1	Pinning	3
6.2	Pin description	3
7	Functional description	4
8	Limiting values	4
9	Recommended operating conditions	4
10	Static characteristics	5
11	Dynamic characteristics	6
12	Waveforms	6
13	Transfer characteristics	8
14	Waveforms transfer characteristics	9
15	Package outline	10
16	Abbreviations	13
17	Revision history	13
18	Legal information	14
18.1	Data sheet status	14
18.2	Definitions.....	14
18.3	Disclaimers.....	14
18.4	Trademarks.....	15
19	Contact information	15
20	Contents	16